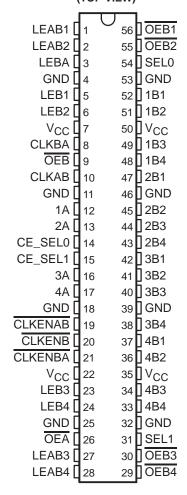
SCBS207F - OCTOBER 1992 - REVISED MAY 1997

- **Members of the Texas Instruments** *Widebus*™ Family
- State-of-the-Art *EPIC-IIB™* BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per **JEDEC Standard JESD-17**
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$
- **High-Impedance State During Power Up** and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package **Using 25-mil Center-to-Center Spacings**

description

The 'ABTH16460 are 4-bit to 1-bit multiplexed registered transceivers used in applications where four separate data paths must be multiplexed onto or demultiplexed from a single Typical path. applications include data multiplexing and/or demultiplexing of address and information in microprocessor bus-interface applications. These devices also are useful in memory-interleaving applications.

SN54ABTH16460 . . . WD PACKAGE SN74ABTH16460 . . . DGG OR DL PACKAGE (TOP VIEW)



Five 4-bit I/O ports (1A-4A, 1B1-4, 2B1-4, 3B1-4, and 4B1-4) are available for address and/or data transfer. The output-enable (OEB, OEB1-OEB4, and OEA) inputs control the bus-transceiver functions. These control signals also allow 4-bit or 16-bit control, depending on the OEB level.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus and EPIC-IIB are trademarks of Texas Instruments Incorporated.



SCBS207F - OCTOBER 1992 - REVISED MAY 1997

description (continued)

Address and/or data information can be stored using the internal storage latches/flip-flops. The latch-enable (LEB1–LEB4, LEBA, and LEAB1–LEAB4) and clock/clock-enable (CLK/CLKEN) inputs are used to control data storage. When either one of the latch-enable inputs is high, the latch is transparent (clock is a don't care as long as the latch enable is high). When the latch-enable input goes low (providing that the clock does not transit from low to high), the data present at the inputs is latched and remains latched until the latch-enable input is returned high. When the clock enable is low and the corresponding latch enable is low, data can be clocked on the low-to-high transition of the clock. When either the clock enable or the corresponding latch enable is high, the clock is a don't care.

Four select pins (SEL0, SEL1, CE_SEL0, and CE_SEL1) are provided to multiplex data (A port), or to select one of four clock enables (B port). This allows the user the flexibility of controlling one bit at a time.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABTH16460 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABTH16460 is characterized for operation from –40°C to 85°C.

Function Tables

A-TO-B OUTPUT ENABLET

INP	INPUTS				
OEB	OEBn	Bn			
Н	Н	Z			
Н	L	Z			
L	Н	Z			
L	L	Active			

 $\dagger n = 1, 2, 3, 4$

A-TO-B STORAGE (assuming OEB = L, OEBn = L)‡

			INPUTS						OUTI	PUTS	
CLKENAB	CE_SEL1	CE_SEL0	CLKAB	LEAB1	LEAB2	LEAB3	LEAB4	B1	B2	В3	В4
Х	Х	Х	H or L	Н	L	L	L	Α	A ₀	A ₀	A ₀
Х	Χ	Χ	H or L	Н	Н	Н	L	Α	Α	Α	A ₀
L	Χ	Χ	L	L	L	L	L	A ₀	A ₀	A ₀	A ₀
L	L	L	\uparrow	L	L	L	L	Α	A_0	A_0	A ₀
L	L	Н	\uparrow	L	L	L	L	A ₀	Α	A_0	A ₀
L	Н	L	\uparrow	L	L	L	L	A ₀	A ₀	Α	A ₀
L	Н	Н	\uparrow	L	L	L	L	A ₀	A ₀	A ₀	Α
Н	Χ	Χ	1	L	L	L	L	A ₀	A ₀	A ₀	A ₀

[‡] This table does not cover all the latch-enable cases since they have similar results.



SCBS207F - OCTOBER 1992 - REVISED MAY 1997

Function Tables (Continued)

B-TO-A STORAGE (before point P)

	INPUTS								
CLKENB	CLKBA	LEB1	LEB2	LEB3	LEB4	SEL1	SEL0	Р	
Х	Х	Н	L	L	L	L	L	B1	
Х	X	L	Н	L	L	L	Н	B2	
Х	X	L	L	Н	L	Н	L	В3	
Х	Χ	L	L	L	Н	Н	Н	B4	
						L	L	B1	
l .	↑	ŧ			1	L	Н	B2	
-	ı	L	L	L	L	Н	L	В3	
						Н	Н	B4	
						L	L	В1 ₀ †	
						L	Н	в2 ₀ †	
	L	L	L	L	L	Н	L	вз ₀ †	
						Н	Н	в4 ₀ †	

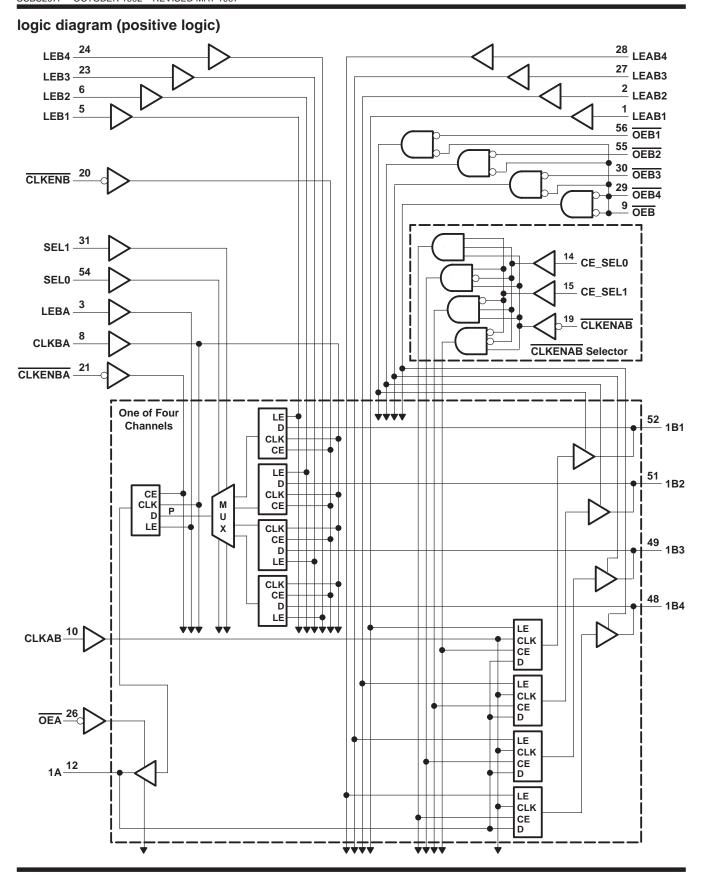
[†] Output level before the indicated steady-state input conditions were established

B-TO-A STORAGE (after point P)

(alter point i)										
	INPUTS									
CLKENBA	CLKBA	LEBA	OEA	В	Α					
Х	Х	Х	Н	Χ	Z					
Х	X	Н	L	L	L					
Х	X	Н	L	Н	Н					
Н	X	L	L	Χ	A ₀ †					
L	\uparrow	L	L	L	L					
L	\uparrow	L	L	Н	Н					
L	L	L	L	Χ	A ₀ †					

[†] Output level before the indicated steady-state input conditions were established

SCBS207F - OCTOBER 1992 - REVISED MAY 1997





SCBS207F - OCTOBER 1992 - REVISED MAY 1997

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (except I/O ports) (see Note 1)	
Voltage range applied to any output in the high or power-off state, VO	–0.5 V to 5.5 V
Current into any output in the low state, I _O : SN54ABTH16460	96 mA
SN74ABTH16460	128 mA
Input clamp current, I _{IK} (V _I < 0)	–18 mA
Output clamp current, I_{OK} ($V_O < 0$)	
Package thermal impedance, θ _{JA} (see Note 2): DGG package	81°C/W
DL package	
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

			SN54ABTI	H16460	SN74ABTH	116460	UNIT
			MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2	2	2		V
V _{IL}	Low-level input voltage			8.0		0.8	V
VI	Input voltage		0 0	Vcc	0	VCC	V
loн	High-level output current		1	-24		-32	mA
lOL	Low-level output current		22	48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled	20%	10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate		200		200		μs/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused control pins must be held high or low to prevent them from floating.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

SCBS207F - OCTOBER 1992 - REVISED MAY 1997

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAD	AMETER	TEST COL	IDITIONS	T	_A = 25°C	;	SN54ABT	H16460	SN74ABTI	116460	UNIT	
TANAMETER		TEST CONDITIONS -		MIN	TYP†	MAX	MIN	MAX	MIN	MAX	UNIT	
٧ıK		$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.2		-1.2		-1.2	V	
		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5			2.5		2.5			
\/~		$V_{CC} = 5 V$,	$I_{OH} = -3 \text{ mA}$	3			3		3		V	
VOH		V _{CC} = 4.5 V	I _{OH} = -24 mA	2			2				V	
		VCC = 4.5 V	I _{OH} = -32 mA	2*					2			
\/a.		V _{CC} = 4.5 V	I _{OL} = 48 mA		0.36			0.5			V	
VOL		VCC = 4.5 V	I _{OL} = 64 mA			0.55*				0.55	V	
V _{hys}					100						mV	
	Control inputs	$V_{CC} = 0$ to 5.5 V, $V_{I} = V_{CC}$ or GND				±1		±1		±1		
l tı	A or B ports	$V_{CC} = 2.1 \text{ V to } 5.5$ $V_I = V_{CC} \text{ or GND}$	V,			±20		±20		±20	μА	
	A = 11 D = 2 = 14	an Dinasta IV. ASIV	V _I = 0.8 V	75		500	75	500	75	500	μΑ	
l(hold)	A or B ports	V _{CC} = 4.5 V	V _I = 2 V	-75		-500	-75	-500	-75	-500		
I _{OZPU} ‡	‡	$V_{CC} = 0 \text{ to } 2.1 \text{ V},$ $V_{O} = 0.5 \text{ V to } 2.7 \text{ V}$	∕, OE = X			±50	Q	±50		±50	μА	
l _{OZPD} ‡	:	V _{CC} = 2.1 V to 0, V _O = 0.5 V to 2.7 \	/, OE = X			±50	Sharing	±50		±50	μА	
I _{off}		$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$			±100	S. C.			±100	μΑ	
ICEX		V _{CC} = 5.5 V, V _O = 5.5 V	Outputs high			50		50		50	μА	
IO§		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-200	-50	-200	-50	-200	mA	
			Outputs high			1.5		1.5		1.5		
		V _{CC} = 5.5 V,	A outputs low			10		10		10	A	
Icc		$I_O = 0$, $V_I = V_{CC}$ or GND	B outputs low			32		32		32	mA	
		1 100 31 311	Outputs disabled			1.5		1.5		1.5		
ΔICC¶		$V_{CC} = 5.5 \text{ V}$, One in Other inputs at V_{C}				1.5		1.5		1.5	mA	
Ci	Control inputs	V _I = 2.5 V or 0.5 V			8						pF	
C _{io}	A or B ports	V _O = 2.5 V or 0.5 \	/		3.5						pF	

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.

[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡]This parameter is characterized but not production tested.

[§] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[¶] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

SCBS207F - OCTOBER 1992 - REVISED MAY 1997

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

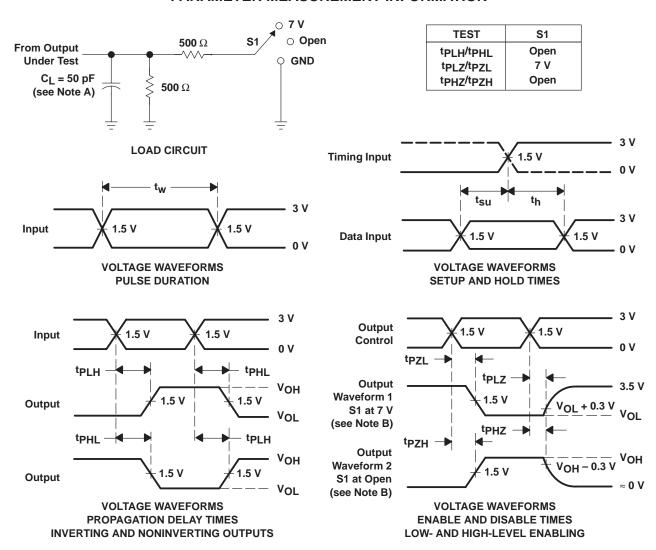
				SN54ABTI	116460	SN74ABTI	H16460	UNIT
				MIN	MAX	MIN	MAX	UNII
fclock	Clock frequency			0	160	0	160	MHz
		CLKAB high or low		3.8		3.8		
		CLKBA high or low		4.5		4.5		
t _W	Pulse duration	LEAB1, 2, 3, or 4 high		2.2		2.2		ns
		LEBA high		2.1		2.1		
		LEB1, 2, 3, or 4 high		2.4		2.4		
			A bus	2.5		2.5		
		Before CLKAB↑	CE_SEL0/1	3.2		3.2		
			CLKENAB	3.2		3.2		
		Before LEAB1, 2, 3, or 4↓	A bus	3.6		3.6		
			B bus	3.8		3.8		
			CLKENB	2.3	N.	2.3		
t _{su}	Setup time	Before CLKBA↑	CLKENBA	2.5	N.	2.5		ns
			LEB1, 2, 3, or 4	4.3	ř.	4.3		
			SEL0/1	4.5		4.5		
		Before LEB1, 2, 3, or 4↓	B bus	3.2		3.2		
			B bus	Q 4		4		
		Before LEBA↓	LEB1, 2, 3, or 4	4.4		4.4		
			SEL0/1	4.3		4.3		
			A bus	0.5		0.5		
		After CLKAB↑	CE_SEL0/1	1.1		1.1		
			CLKENAB	0.5		0.5		
		After LEAB1, 2, 3, or 4↓	A bus	1.2		1.2		
			B bus	1.3		1.3		
th	Hold time	After CLKBA↑	CLKENB	1		1		ns
	AILEI CLADAT	CLKENBA	1		1			
			SEL0/1	0		0		
		After LEB1, 2, 3, or 4↓	B bus	1.5		1.5		
		After LEBA↓	B bus	0.4		0.4		
		Ailei LEDAV	SEL0/1	0.1		0.1		

SCBS207F - OCTOBER 1992 - REVISED MAY 1997

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)			CC = 5 V 4 = 25°C	', :	SN54ABT	H16460	SN74ABTI	UNIT	
	(INPOT)	(001701)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f _{max}			160			160		160		MHz
^t PLH	В	А	2.5	3.6	5.9	2.5	7.1	2.5	6.5	
^t PHL]	A	2	3.5	5.8	2	6.8	2	6.5	ns
^t PZH	OEA	А	1.5	2.8	4.8	1.5	5.9	1.5	5.6	ns
^t PZL] OEA	A	1.5	2.6	4.6	1.5	5.5	1.5	5.2	115
^t PHZ		А	2.5	3.8	5.3	2.5	6	2.5	5.9	ns
t _{PLZ}	OEA	A	1.5	4.6	6.1	1.5	7	1.5	6.5	115
t _{PLH}	A	В	2	3.2	5.2	2	6.2	2	5.7	ns
^t PHL	7 ^	Ь	1.5	3.1	5.2	1.5	6.1	1.5	5.7	115
^t PZH	<u> </u>	В	1.5	3.3	5.7	1.5	6.7	1.5	6.4	ns
^t PZL	OEB	Ь	1.5	3.2	5.5	1.5	6.6	1.5	6.3	115
^t PHZ	<u> </u>	В	3	4.7	6.3	3 4	7.1	3	7	ns
t _{PLZ}	OEB		2	4	5.5	2	6.6	2	6.1	113
^t PZH		В	1.5	3	5.2	1.5	6	1.5	5.8	ns
t _{PZL}	OEB1, 2, 3, 4	Ь	1.5	2.9	4.9	1.5	5.9	1.5	5.6	115
^t PHZ	<u></u>	В	2.5	4	5.7	2.5	6.2	2.5	6.1	no
t _{PLZ}	OEB1, 2, 3, 4	Ь	1.5	3.5	4.8	1.5	5.8	1.5	5.3	ns
^t PLH	CLKBA	А	1.5	4.2	6.7	1.5	8.1	1.5	7.4	ns
^t PHL	CLRBA	A	1.5	4.4	6.9	1.5	8.4	1.5	7.7	115
^t PLH	CLKAB	В	2	3.4	5.6	2	6.8	2	6.2	ns
^t PHL	CLRAB	В	2	3.4	5.3	2	6.3	2	5.9	115
^t PLH	LEBA	А	2	3	5	2	6.1	2	5.6	ns
^t PHL	LLDA	^	2	3.1	4.8	2	5.8	2	5.3	115
^t PLH	LEAB1, 2, 3, 4	В	2	3.2	5.2	2	6.3	2	5.8	ns
^t PHL	LLAD1, 2, 3, 4		2	3.3	5	2	6.1	2	5.6	113
^t PLH	LEBA1, 2, 3, 4	А	2.5	4	6.5	2.5	7.8	2.5	7.2	ns
^t PHL		^	2.5	4	6.1	2.5	7.5	2.5	6.8	115
^t PLH	SEL	А	2	4.1	6.7	2	8.1	2	7.5	ns
^t PHL		^	2	3.8	6.2	2	7.3	2	6.9	115

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z $_{O}$ = 50 Ω , t_{f} \leq 2.5 ns, t_{f} \leq 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46C and to discontinue any product or service per JESD48B. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components which meet ISO/TS16949 requirements, mainly for automotive use. Components which have not been so designated are neither designed nor intended for automotive use; and TI will not be responsible for any failure of such components to meet such requirements.

roducts		Applications
	ti aaaa/adia	A

Pr

Audio Automotive and Transportation www.ti.com/automotive www.ti.com/audio www.ti.com/communications **Amplifiers** amplifier.ti.com Communications and Telecom **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** Consumer Electronics www.ti.com/consumer-apps www.dlp.com DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical Logic logic.ti.com Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

OMAP Mobile Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity www.ti.com/wirelessconnectivity